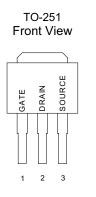
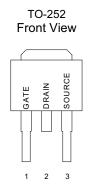


GENERAL DESCRIPTION

This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

PIN CONFIGURATION

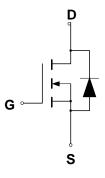




FEATURES

- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- I_{DSS} and V_{DS}(on) Specified at Elevated Temperature

SYMBOL



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS

Rating		Value	Unit
Drain to Current – Continuous		1.0	А
 Pulsed 	I _{DM}	9.0	
Gate-to-Source Voltage – Continue		±30	V
 Non-repetitive 	V _{GSM}	±40	V
Total Power Dissipation			W
TO-251/252		50	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to 150	°C
Single Pulse Drain-to-Source Avalanche Energy $- T_J = 25^{\circ}C$		20	mJ
$(V_{DD} = 100V, V_{GS} = 10V, I_{AS} = 2A, L = 10mH, R_G = 25\Omega)$			
Thermal Resistance – Junction to Case	θ _{JC}	1.0	°C/W
 Junction to Ambient 	θ _{JA}	62.5	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	°C



ORDERING INFORMATION

Part Number	Package		
ST1N60-251	TO-251		
ST1N60-252	TO-252		

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, $T_J = 25^{\circ}C$.

				ST1N60		Units
Characteristic		Symbol	Min	Тур	Max	
Drain-Source Breakdown Voltage		V _{(BR)DSS}	600			V
$(V_{GS} = 0 V, I_D = 250 \mu A)$						
Drain-Source Leakage Current		I _{DSS}				mA
$(V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V})$					0.1	
$(V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125^{\circ}\text{C})$					0.3	
Gate-Source Leakage Current-Forward		I _{GSSF}			100	nA
(V _{gsf} = 20 V, V _{DS} = 0 V)						
Gate-Source Leakage Current-Revers	e	I _{GSSR}			100	nA
$(V_{gsr} = 20 V, V_{DS} = 0 V)$						
Gate Threshold Voltage		V _{GS(th)}	2.0		4.0	V
$(V_{DS} = V_{GS}, I_D = 250 \ \mu A)$						
Static Drain-Source On-Resistance (V	_{GS} = 10 V, I _D = 0.6A) *	R _{DS(on)}			8.0	Ω
Forward Transconductance (V _{DS} \geq 5	0 V, I _D = 0.5A) *	g FS	0.5			mhos
Input Capacitance	$(V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz)$	C _{iss}		210		pF
Output Capacitance		C _{oss}		28		pF
Reverse Transfer Capacitance		C _{rss}		4.2		pF
Turn-On Delay Time	$(V_{DD} = 300 \text{ V}, I_D = 1.0 \text{ A},$ $V_{GS} = 10 \text{ V},$ $R_G = 18\Omega) *$	t _{d(on)}		8		ns
Rise Time		tr		21		ns
Turn-Off Delay Time		t _{d(off)}		18		ns
Fall Time		t _f		24		ns
Total Gate Charge	(V _{DS} = 400 V, I _D = 1.0 A, V _{GS} = 10 V)*	Qg		8.5	14	nC
Gate-Source Charge		Q _{gs}		1.8		nC
Gate-Drain Charge		Q _{gd}		4		nC
Internal Drain Inductance		L _D		4.5		nH
(Measured from the drain lead 0.25'	from package to center of die)					
Internal Drain Inductance		Ls		7.5		nH
(Measured from the source lead 0.2	5" from package to source bond pad)					
SOURCE-DRAIN DIODE CHARACTE	RISTICS					
Forward On-Voltage(1)	$(I_{\rm S} = 1.0 \text{ A}, V_{\rm GS} = 0 \text{ V},$	V _{SD}			1.5	V
Forward Turn-On Time		t _{on}		**		ns
Reverse Recovery Time	$d_{IS}/d_{t} = 100A/\mu s)$	t _{rr}		350	500	ns

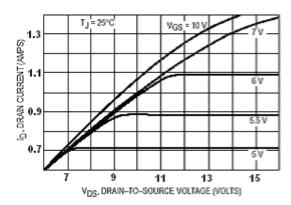
* Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%

** Negligible, Dominated by circuit inductance

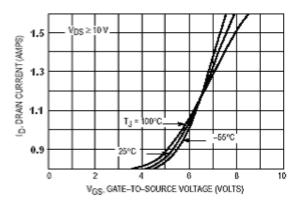


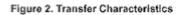
ST1N60 POWER MOSFET

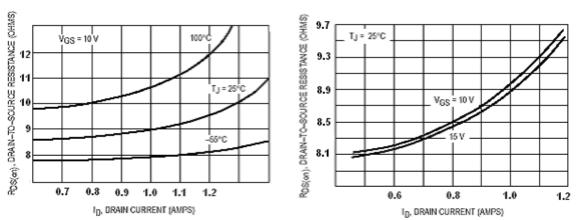
TYPICAL ELECTRICAL CHARACTERISTICS













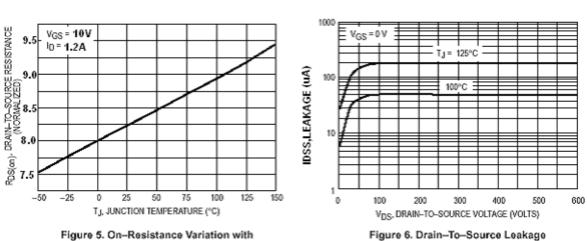


Figure 3. On-Resistance versus Drain Current and Temperature

Temperature

Figure 6. Drain-To-Source Leakage Current versus Voltage

Figure 4. On-Resistance versus Drain Current

and Gate Voltage

